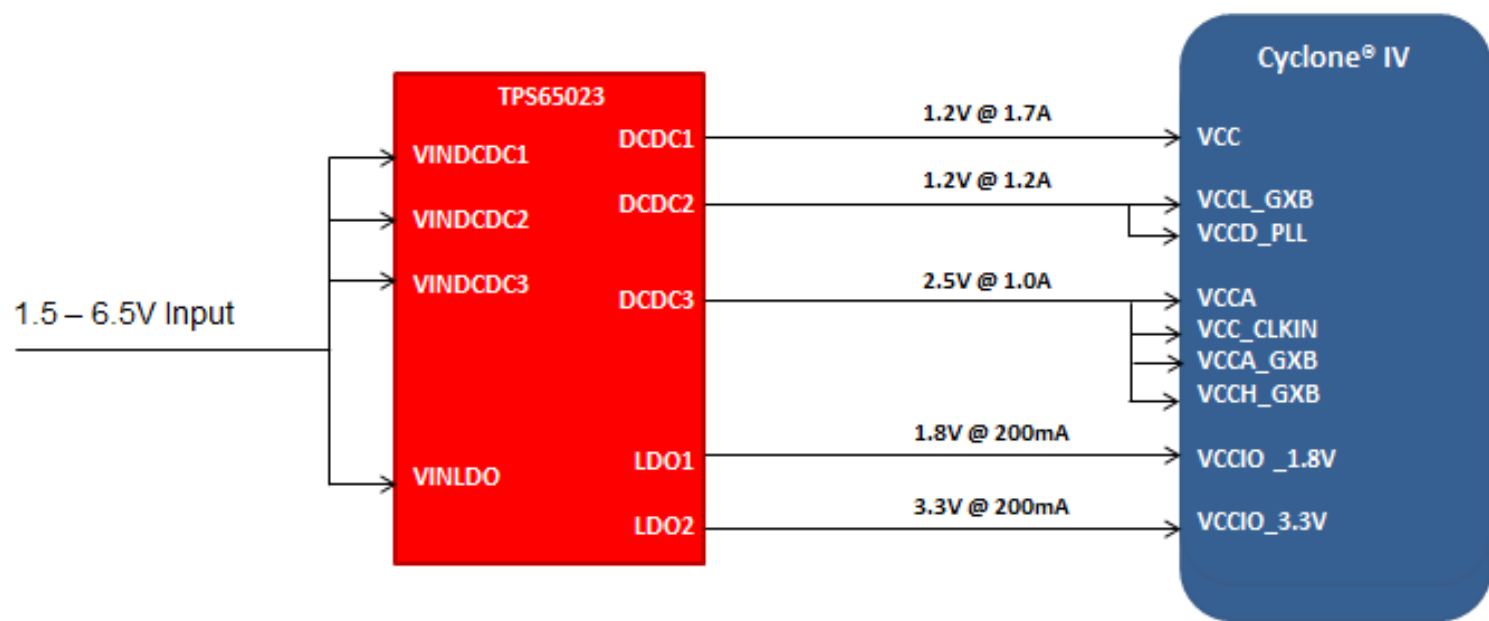
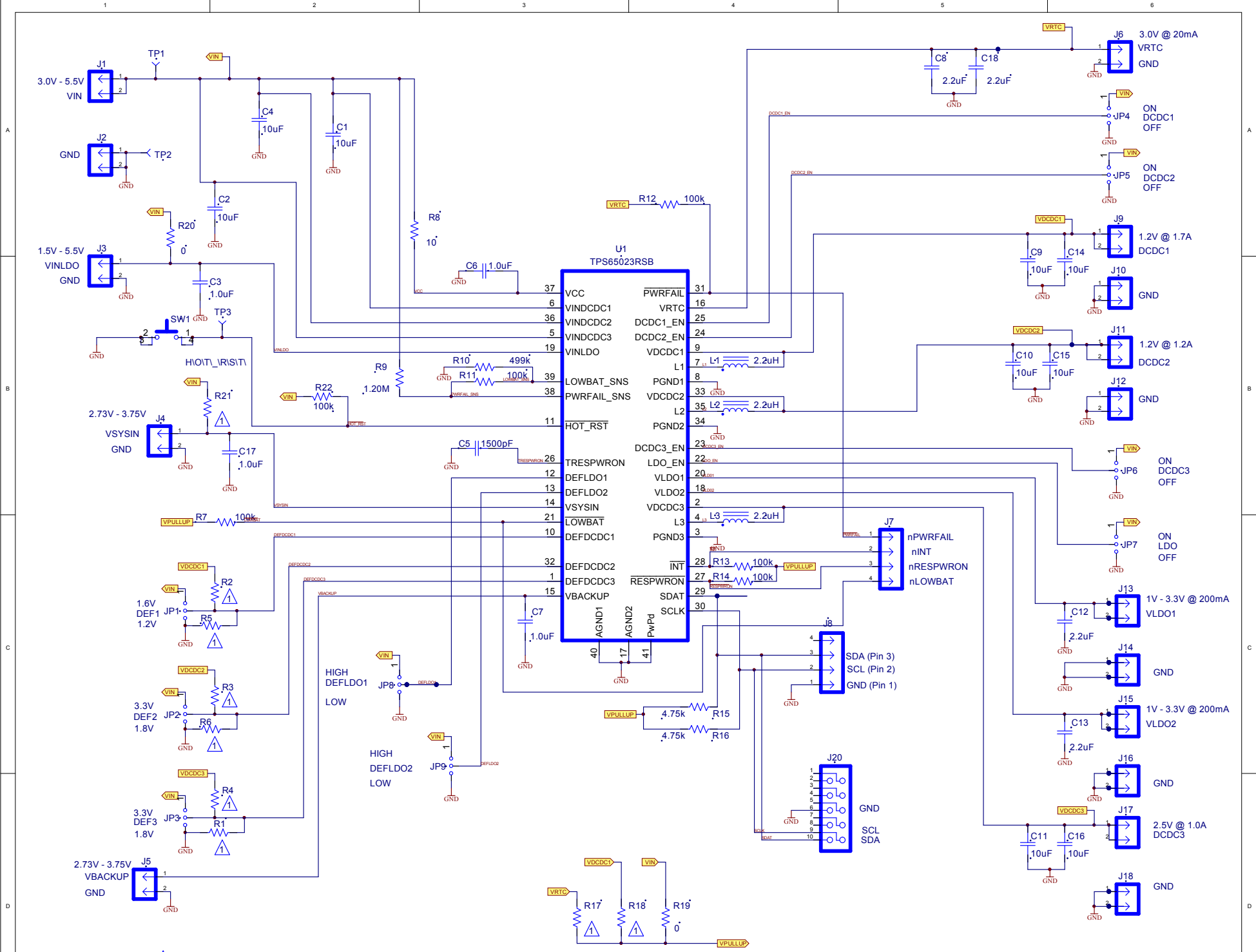


Revision History				
Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A

Altera® Cyclone® IV TPS65023 Block Diagram





1 See BOM

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Orderable: N/A	Designed for: Public Release	Mod. Date: 6/9/2015	
TID #: TIDA-00605	Project Title: Altera Cyclone IV FPGA Power Reference Design	Sheet: 2 of 3	
Number: TIDA-00605	Rev: E1	Assembly Variant: [No Variations]	
SVN Rev: Version control disabled	File: TIDA-00605_SchDoc	Size: B	http://www.ti.com
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